APPLICATION FOR EXTENSION OF ESCC QUALIFICATION APPROVAL

Component Title: **CMOS B, 4000B Series**

Executive Member: CNES Date: 13/02/2024

Appl. No. 73U

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Components (including series and families) submitted for Extension of Qualification Approval:

ESCC COMPONENT NO.	VARIANTS	RANGE OF COMPONENTS	BASED ON	TEST VEHICLE / S	COMPONENT SIMILAR
As per QPL				**HCC4013BHG**	As per QPL
				HCC4066BKG	
				HCC40109BKG	
				HCC4047BKG	
				HCC40106BKG	

2 Component Manufacturer

STMicroelectronics

3 Location of Manufacturing Plant(s)

Rennes, FRANCE

4

Date of original qualification approval:

Date: 01/04/1981

Certificate Ref No. 73

5

ESCC Specifications used for Maintenance of qualification testing:

Generic: 9000 Issue: 11

Detail(s): 9203/023 Issue: 6
9408/005 5
9407/003 6
9207/003 5
9409/005 5

6

Deviations to LVT testing and Detail Specification used:

No ☒ Yes ☐ (supply details in Box 15)

Deviation from current Specifications:

No ☒ Yes ☐ (Supply details)

7

Qualification Extension Report reference and date:

HCC4013BHG - ID33027004YZ DC2217A
HCC4066BKG - ID33312F6H01 DC2314A
HCC40109BKG - ID33548003Y3 DC2220A
HCC4047BKG - ID33312F6801 DC2314A
HCC40106BKG - ID33549002YD DC2219A

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Summary of procurement or equivalent test results during current validity period in support of this application (those to ESCC listed first)

Customer Name	Testing Level	LAT	Date code	Quantity Delivered
See Excel File	ESCC9000 Issue 11		Lots delivered from January 2022 to November 2023	31 605

9

PID changes since start of qualification

None ☐

Minor* ☐

Major* ☒ *Provide details in box:

10

Current **PID** Verified by: L. Baczkowski, CNES

Name of Excutive Representative

Ref No: PID GENERIQUE Ref. 8097046 revision 37.0, 30/05/2023, PID CMOS4000B Ref. 8237618 rev.16.0, 30/10/2023

Issue: 37.0 (Gen) & 16.0 (CMOS) Date: 13/02/2024

Rev Date:

11

Current Manufacturing facilities surveyed by: JB Sauveplane, CNES on 12/07/2023

(Name of Executive Representative) (Date)

Satisfactory: Yes ☒ No ☐ Explain MoM Quality Meeting held on the 7-8th of Octobre 2021 (generic PID audit)
MoM Quality Meeting held on the 12th of July 2023 (B2015)

Report Reference: CR-Visite octobre 2021
CR-Activités ST Juillet 2023

12

Failure Analysis, DPA, NCCS available: Yes ☐ No ☒ (Supply data)

Ref. No's and purposes:

13

The undersigned hereby certifies on behalf of the ESCC Executive - that the above information is correct; - that the appropriate documentation has been evaluated; - that full compliance to all ESCC requirements is evidence (except as stated in box 15;) - that the reports and data are available at the ESCC Executive and therefore applies on behalf of CNES as the responsible Executive Member for ESCC qualification status to be extended to the component(s) listed herein.

Date: 13/02/2024

Gianandrea Quadri
G. QUADRI, CNES
(Signature of the Executive Coordinator)

Continuation of Boxes above:

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[7] Qualification Extension reports :

The extension is based on collection of 54HCMOS and CMOS 4000B data :

AMK 5":

HCC4013BHG - ID33027004YZ DC2217A - ESCC9000 Chart F4 sg2

HCC4066BKG - ID33312F6H01 DC2314A - ESCC9000 Chart F4 sg2

AMK 6":

HCC40109BKG - ID33548003Y3 DC2220A - ESCC9000 Chart F4 sg2

HCC4047BKG - ID33312F6801 DC2314A - ESCC9000 Chart F4 sg2

Package qualification:

Dual in Line: M54HC14DG ID33611001Y3 DC2219A - ESCC 9000 chart F4 sg1-3

Flat pack: HCC40106BKG ID33549002YD DC2219A - ESCC 9000 chart F4 sg1-3

Cover the validation of packages for both families as agreed by Qualification Board at its march 2001 meeting.

[9] Minor PID changes:

- PID GENERIQUE Ref. 8097046 → cf Histo_GENERIC_PID.txt

- PID CMOS Ref. 8237618 → cf Histo_PID_CMOS.txt

15

Non compliance to ESCC requirements:

No.:	Specification	Paragraph	Non compliance

16

Additional tasks required to achieve full compliance for ESCC qualification or rationale for acceptability of noncompliance:

17

Executive Manager Disposition

Application Approval: Yes ☒ No ☐

Action / Remarks:

Date:

B. Schade: Head of the Product Assurance and Safety Department

ANNEX 1: LIST OF TESTS DONE TO SUPPORT EXTENSION OF QUALIFICATION 18

Tests conducted in compliance with:

- ESCC 9000 generic specification; Chart F4 (for ESCC/QPL parts);
- Or PID-TFD (for ESCC/QML parts)

Tests vehicle identification/description:

AMK 5": **HCC4013BHG - ID33027004YZ DC2217A** **HCC4066BKG - ID33312F6H01 DC2314A**	**AMK 6":** **HCC40109BKG - ID33548003Y3 DC2220A** **HCC4047BKG - ID33312F6801 DC2314A**
Dual in Line: M54HC14DG - ID33611001Y3 DC2219A **Flat pack: HCC40106BKG - ID33549002YD DC2219A**	**Cover the validation of packages for both CMOS4000B and 54HCMOS families as agreed by Qualification Board at its march 2001 meeting.**

Detail Specification reference: 9203/023, 9408/005, 9407/003, 9207/003, 9409/005...

Chart F4	Test	Tick when done	Conditions	Date Code Diffusion Lot	Tested Qty	No. of Rejects	Comments if not performed. Comments on Rejection
Environmental/Mechanical Subgroup	Mechanical Shock	☒	MIL-STD-883, Test Method 2002	Dual in Line: M54HC14DG - ID33611001Y3 DC2219A Flat pack: HCC40106BKG - ID33549002YD DC2219A	15	0	
	Vibration	☒	MIL-STD-883, Test Method 2007		15	0	
	Constant Acceleration	☒	MIL-STD-883, Test Method 2001		15	0	
	Seal (Fine and Gross Leak)	☒	MIL-STD-883, Test Method 1014		15	0	
	Intermediate and End-Point Electrical Measurements	☒	Intermediate and End-Point Electrical Measurements in the Detail Specification		15	0	
	External Visual Inspection	☒	ESCC Basic Specification No. 20500		15	0	
	Thermal Shock	☒	MIL-STD-883. Test Method 1011		15	0	
	Temperature cycling	☒	MIL-STD-883. Test Method 1010		15	0	
	Moisture Resistance	☒	MIL-STD-883, Test Method 1004		15	0	
	Seal (Fine and Gross Leak)	☒	MIL-STD-883, Test Method 1014		15	0	
	Intermediate and End-Point Electrical Measurements	☒	Intermediate and End-Point Electrical Measurements in the Detail Specification		15	0	
	External Visual Inspection	☒	ESCC Basic Specification No. 20500		15	0	

Chart F4	Test	Tick when done	Conditions	Date Code Diffusion Lot	Tested Qty	No. of Rejects	Comments if not performed. Comments on Rejection
Endurance Subgroup	Operating Life	☒	MIL-STD-883, Test Method 1005	AMK 5":	15	0	
	Intermediate and End-Point Electrical Measurements	☒	Intermediate and End-Point Electrical Measurements in the Detail Specification	HCC4013BHG - ID33027004YZ DC2217A	15	0	
	Seal (Fine and Gross Leak)	☒	MIL-STD-883, Test Method 1014	HCC4066BKG - ID33312F6H01 DC2314A	15	0	
	External Visual Inspection	☒	ESCC Basic Specification No. 20500	AMK 6": HCC40109BKG - ID33548003Y3 DC2220A HCC4047BKG - ID33312F6801 DC2314A	15	0	
Assembly Capability Subgroup	Permanence of Marking	☐	ESCC Basic Specification No. 24800	Dual in Line: M54HC14DG - ID33611001Y3 DC2219A			Not applicable
	Terminal Strength	☒	MIL-STD-883, Test Method 2004		/	/	
	Internal Visual Inspection	☒	ESCC Basic Specification No. 20400		3	0	
	Bond Strength	☒	MIL-STD-883 Test Method 2011		2	0	
	Die Shear or Substrate Attach Strength	☒	MIL-STD-883 Test Method 2019 or 2027	Flat pack: HCC40106BKG - ID33549002YD DC2219A	2	0	
Additional Tests		☐					
		☐					
		☐					

NOTES ON THE COMPLETION OF THE APPLICATION FORM FOR ESCC QUALIFICATION EXTENSION APPROVAL

ENTRIES

Form heading	shall indicate: - the title of the component as given in its detail specification or the name of the series, family; - the Executive Member; - the entering date; - the certificate number and its sequential suffix.
Box 1	shall provide details given in the table; in particular there shall be listed: - the variants or range of variants; - the range of components (the ESCC code is recommended to indicate the values or values range, the tolerance, the voltage, etc); the designation given in the detail specification as 'base on'; - under Test Vehicle enter either an ESCC code or the specific characteristic capable of identifying the component tested (e.g., voltage of coil for a relay); - under component similar enter a cross if relevant.
Box 2; 3 and 4	As per QPL entry; otherwise, an explanation of the changes must be supplied.
Box 5	Will show the ESCC Generic and Detail specifications, including issue number and revision letter, current at the time the tests reported were performed. If the specifications are different from those current on the date of the application, see Box 6.
Box 6	Will show the deviations from the Generic and Detail Specifications listed in Box 5, in particular deviations from testing. In case of deviations this must be listed in Box 15. In case the referenced specification in Box 5 have currently a different issue and/or revision indicate also whether the test data deviates or not from such current documents.
Box 7	Must reference the report(s) supplied in support of the application.
Box 8	Should provide the details of procurement to the full ESCC System, documentation of all of which should already have been delivered to the ESCC Executive under the terms of the relevant Generic Specification. An appropriate table has been drawn in this box.
Box 9	If the PID evolved after the Original Qualification or after the last Extension of Qualification, adequate details of such evolution shall be provided together with the reasons for the changes. Major changes shall be clearly marked.
Box 10	Identify the current PID issue status, date and actual date of verification. The date of verification of the current PID should be arranged as close as possible to the required date of extension.
Box 11	This box can be completed only after a physical visit to the plant to confirm that no unexplained changes occurred and that the practices, procedures, material, etc. used in manufacturing the components are as described in the PID. This survey shall be carried out in accordance with the requirements of ESCC Basic Specification No. 20200 and its findings shall be recorded.
Box 12	Provide details of, or reference to, any Destructive Physical Analysis (DPA) and Failure Analysis reports as well as any Nonconformance(s) (NCCS) occurred during the qualification validity period, stating if established corrective action have produced satisfactory results.
Box 13	Enter only the name of the Executive Member (i.e., CNES, DLR, ESTEC, etc.) and the signature of the responsible Executive Coordinator.
Box 14	To be used when there is a need to expand any of the boxes from 1 through 12. Identify box affected and reference the Box 14 in the relevant Box. Box 14 can be broken into 14a, 14b, etc. if several boxes have to be expanded.
Box 15	Fill in Table as requested.
Box 16	Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.
Box 17	All Executive Manager recommendations on the application itself, special conditions or restrictions, modifications of the QPL or QML entry, letters to the manufacturer, etc. shall be entered clearly in Box 19, signed by the representative for ESA, and dated.
Box 18	Fill in Table as requested.
Box 19	Confidential Details of PID changes including those of a confidential nature, shall be provided.
Box 20	State noncompliance with reference to specification(s) and paragraph(s). To simplify reference in Box 16 each nonconformance shall be sequentially numbered. If relevant state 'None'.
Box 21	Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.
Box 22	Additional Comments.